

# AUF4104-VB Datasheet N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub>	40	V		
$R_{DS(on)} V_{GS} = 10 V$	6	mΩ		
I <sub>D</sub>	110	Α		
Configuration	Single			

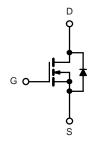
### **FEATURES**

- Trench Power MOSFET
- 100 %  $\rm R_{\rm g}$  and UIS Tested



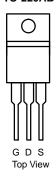
### **APPLICATIONS**

- Synchronous Rectification
- Power Supplies



N-Channel MOSFET

## TO-220AB



<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25  ^{\circ}C$ , unless Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	40		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		110 <sup>a, c</sup>		
Continuous Proin Current (T = 175 °C)	T <sub>C</sub> = 70 °C		90°		
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub> —	31 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		25 <sup>b</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	270		
lanche Current Pulse L = 0.1 mH		I <sub>AS</sub>	85		
Single Pulse Avalanche Energy	L = 0.1 mn	E <sub>AS</sub>	320	V	
0 11 0 0 0 1	T <sub>C</sub> = 25 °C	L	110 <sup>a, c</sup>	Δ.	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub> —	2.6 <sup>b</sup>	A	
	T <sub>C</sub> = 25 °C		312 <sup>a</sup>		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	D	200	10/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub> —	3.13 <sup>b</sup>	W	
	T <sub>A</sub> = 70 °C		2.0 <sup>b</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	32	40	°C/W	
Maximum Junction-to-Case	Steady State	$R_{thJC}$	0.33	0.4	- C/VV	

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. Calculated based on maximum junction temperature. Package limitation current is 110  $\,\mathrm{A.}$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					1	1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250 A		41		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_{J}$	I <sub>D</sub> = 250 μA		- 8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zana Cata Maltana Busin Comment		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	10		10	μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
D : 0	В	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$	6				
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		7		mΩ	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_{D} = 30 \text{ A}$		180		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			2900			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		750		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			310			
Total Gate Charge	$Q_g$			130		nC	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		20			
Gate-Drain Charge	$Q_{gd}$			32		1	
Gate Resistance	$R_g$	f = 1 MHz		0.85	1.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		11	17		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong 20$ A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		77	115		
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			102	155	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		62	95		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong 20$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		180	270		
Fall Time	t <sub>f</sub>			60	90	1	
<b>Drain-Source Body Diode Characteristi</b>	cs				l		
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			110	^	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				200	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 20 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	75	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I_ = 20 A di/dt = 100 A/us T = 25 °C		70	105	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		30			
Reverse Recovery Rise Time	t <sub>b</sub>	1		20		ns	

#### Notes:

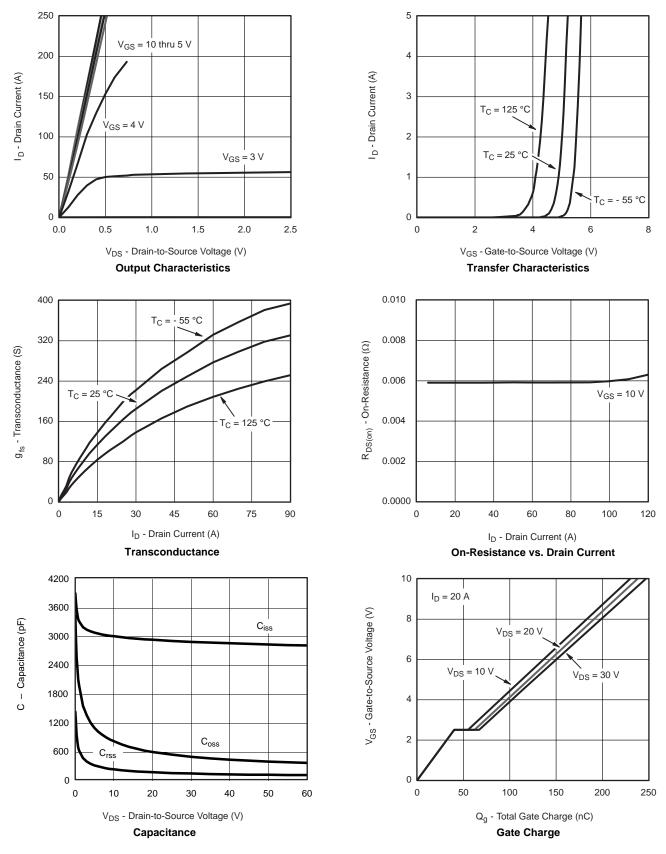
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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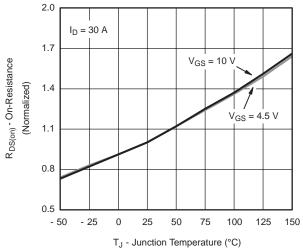
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



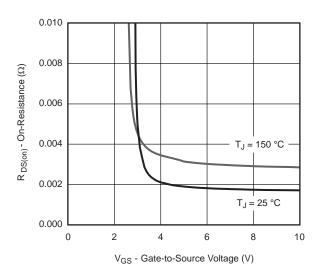
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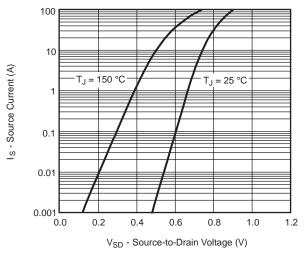
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#### On-Resistance vs. Junction Temperature



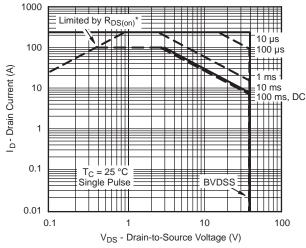
On-Resistance vs. Gate-to-Source Voltage



Forward Diode Voltage vs. Temperature



Threshold Voltage

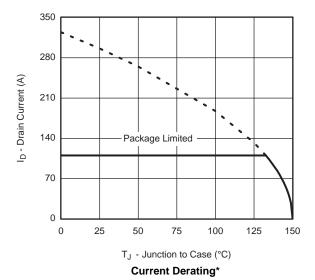


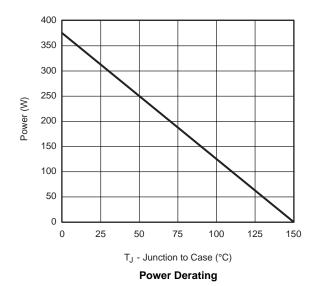
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

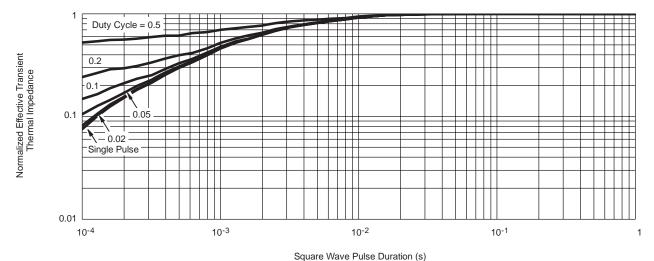


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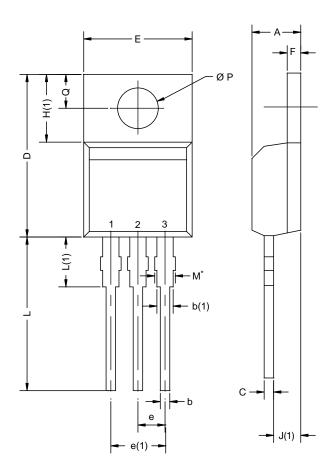
\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case



# **TO-220AB**



	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471					

#### Notes

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 $<sup>^{\</sup>star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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